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Unit: mm

TOSHIBA Power Transistor Module Silicon NPN Triple Diffused Type (Four Darlington Power Transistors inOne)

MP4506

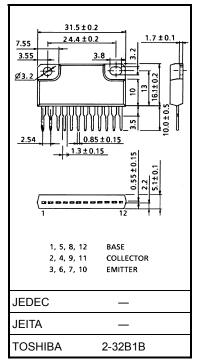
High Power Switching Applications

Hammer Drive, Pulse Motor Drive and Inductive Load Switching

- Package with heat sink isolated to lead (SIP 12 pins)
- High collector power dissipation (4-device operation) : $P_T = 5 W (T_a = 25^{\circ}C)$
- High collector current: I_C (DC) = 5 A (max)
- High DC current gain: $h_{FE} = 1000$ (min) ($V_{CE} = 3 \text{ V}$, $I_C = 3 \text{ A}$)

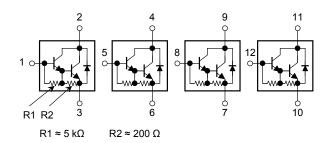
Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Collector-base voltage		V _{CBO}	100	V	
Collector-emitter voltage		V _{CEO}	100	V	
Emitter-base voltage		V _{EBO}	5	V	
Collector current	DC	Ι _C	5	А	
	Pulse	I _{CP}	8	A	
Continuous base current		Ι _Β	0.1	A	
Collector power dissipation (1-device operation)		P _C	3.0	W	
Collector power dissipation	Ta = 25°C	Рт	5.0	W	
(4-device operation)	Tc = 25°C	. 1	25		
Isolation voltage		V _{Isol}	1000	V	
Junction temperature		Тј	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 6.0 g (typ.)

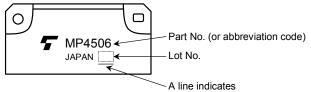
Array Configuration



Industrial Applications

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Marking



A line indicates lead (Pb)-free package or lead (Pb)-free finish.

Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance from junction to ambient	ΣR _{th (j-a)}	25	°C/W	
(4-device operation, $Ta = 25^{\circ}C$)	• /			
Thermal resistance from junction to case	ΣR _{th (j-c)}	5.0	°C/W	
(4-device operation, $Tc = 25^{\circ}C$)	- 6 - /			
Maximum lead temperature for soldering purposes	ΤL	260	°C	
(3.2 mm from case for 10 s)	_			

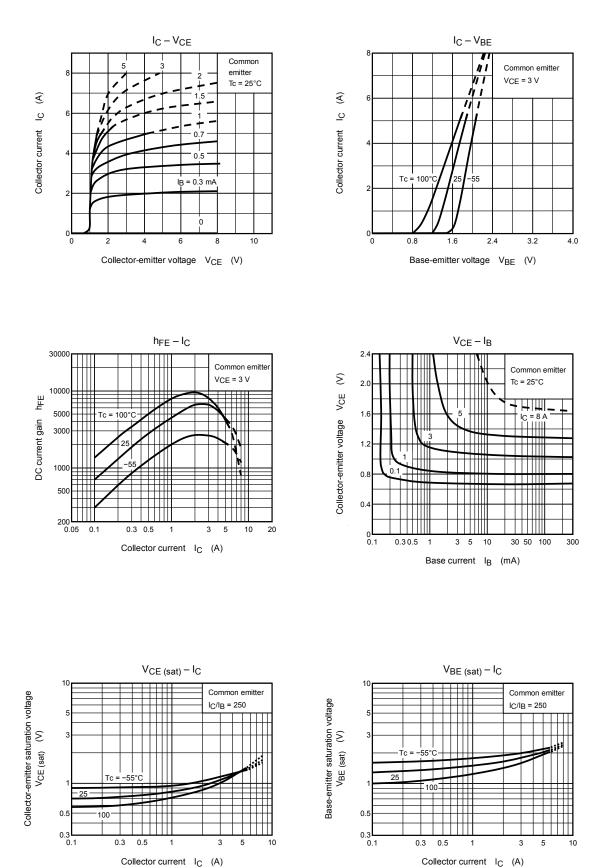
Electrical Characteristics (Ta = 25°C)

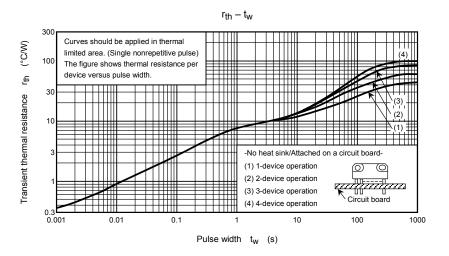
Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off cu	rrent	I _{CBO}	V _{CB} = 100 V, I _E = 0 A	—	—	10	μA
Collector cut-off cu	rrent	ICEO	V _{CE} = 100 V, I _B = 0 A	_	_	10	μA
Emitter cut-off curr	ent	I _{EBO}	V _{EB} = 5 V, I _C = 0 A	0.3	_	2.0	mA
Collector-base brea	akdown voltage	V (BR) CBO	I _C = 1 mA, I _E = 0 A	100	_	_	V
Collector-emitter b	reakdown voltage	V (BR) CEO	I _C = 30 mA, I _B = 0 A	100	_	_	V
DC current gain		h _{FE (1)}	V _{CE} = 3 V, I _C = 0.5 A	1000	_	_	
		h _{FE (2)}	V _{CE} = 3 V, I _C = 3 A	1000	_	_	
Saturation voltage	Collector-emitter	V _{CE (sat)}	I _C = 3 A, I _B = 12 mA	_	_	2.0	v
	Base-emitter	V _{BE (sat)}	I _C = 3 A, I _B = 12 mA	_	—	2.5	
Transition frequency		fT	V _{CE} = 3 V, I _C = 0.5 A	3	_	-	MHz
Collector output capacitance		C _{ob}	V _{CB} = 10 V, I _E = 0 A, f = 1 MHz	_	40	_	pF
Switching time Store	Turn-on time	t _{on}	$\begin{array}{c} \text{Output} \\ \text{Input} \\ \text{20 } \mu \text{s} \\ \text{IB2} \\ \text{IB2} \\ \text{Vcc} = 30 \\ \text{Vcc} =$	_	0.5	_	
	Storage time	t _{stg}		_	3.0	_	μs
	Fall time	t _f	$I_{B1} = -I_{B2} = 12 \text{ mA, duty cycle} \le 1\%$	_	2.0	_	

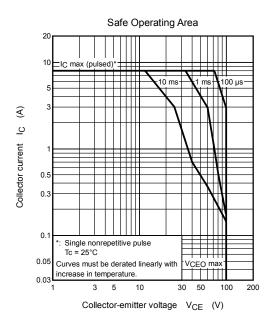
Emitter-Collector Diode Ratings and Characteristics (Ta = 25°C)

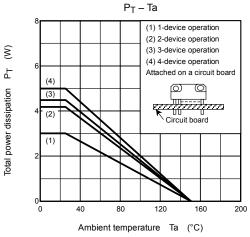
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Maximum forward current	I _{FM}	—	_	_	5	А
Surge current	I _{FSM}	t = 1 s, 1 shot	_	_	8	А
Forward voltage	VF	I _F = 1 A, I _B = 0 A	_	1.2	1.8	V
Reverse recovery time	t _{rr}	I _F = 3 A, V _{BE} = −3 V, dI _F /dt = −50 A/µs	_	1.0	_	μs
Reverse recovery charge	Q _{rr}		_	5	—	μC

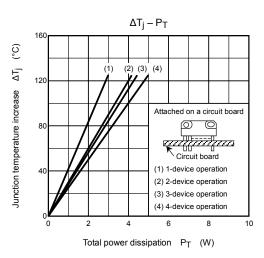
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